



**3V LVTTTL-TO-DIFFERENTIAL  
LVPECL AND DIFFERENTIAL  
LVPECL-TO-LVTTTL TRANSLATOR**

**Precision Edge®  
SY89328L**

**FEATURES**

- 3.3V ±10% power supply
- Guaranteed AC parameters over temperature:  
f<sub>MAX</sub> > 275MHz (LVTTTL)
- < 2ns LVPECL-to-LVTTTL propagation delay
- < 600ps LVTTTL-to-LVPECL propagation delay
- Internal 75kΩ input pull-up and pull-down resistors
- Industrial temperature range: -40°C to +85°C
- Available in ultra-small 8-pin MLF™ (2mm × 2mm) package

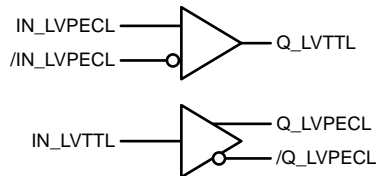


Precision Edge®

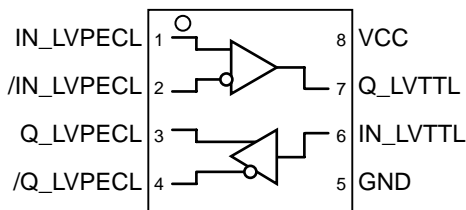
**DESCRIPTION**

The SY89328L is a differential LVPECL-to-LVTTTL translator and an LVTTTL-to-differential LVPECL translator in a single package. Because LVPECL (Positive ECL) levels are used, only +3.3V and ground are required. The SY89328L is functionally equivalent to the SY100EPT28L, but in an ultra-small 8-lead MLF™ package that features a 70% smaller footprint. This ultra-small package and the dual translation design of the SY89328L make it ideal for applications that are sending and receiving signals across a backplane.

**BLOCK DIAGRAM**



**PACKAGE/ORDERING INFORMATION**



8-Pin MLF™

Ultra-Small Outline (2mm × 2mm)

**Ordering Information**

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY89328LMITR	MLF-8	Industrial	HEP28	Sn-Pb
SY89328LMGTR	MLF-8	Industrial	HEP28 with Pb-Free bar-line indicator	Pb-Free NiPdAu

**PIN DESCRIPTION**

Pin Number	Pin Name	Type	Pin Function
1, 2	IN_LVPECL, /IN_LVPECL	100k ECL Input	Differential LVPECL Input: Includes internal 75kΩ pull-down resistor on internal 75kΩ pull-up and pull-down resistors on /IN. See “Input Interface Applications” section for single-ended inputs.
7	Q_LVTTL	LVTTL Output	Single-ended LVTTL Output: Translated from LVPECL input. Q_LVTTL output will default LOW with IN_LVPECL and /IN_LVPECL inputs left open.
6	IN_LVTTL	LVTTL Input	Single-ended LVTTL Input.
3, 4	Q_LVPECL, /Q_LVPECL	100k ECL Output	Differential LVPECL Output: Translated from LVTTL input. See “Output Interface Applications” section for recommendations on terminations.
8	VCC	VCC Power	Positive Power Supply: Bypass with 0.1μF//0.01μF low ESR capacitors.
5	GND, Exposed Pad	Ground	GND and exposed pad must be tied to ground plane.

### Absolute Maximum Ratings<sup>(Note 1)</sup>

Supply Voltage ( $V_{CC}$ )	.....	-0.5V to +3.8V
Input Voltage ( $V_{IN}$ )	.....	-0.5V to $V_{CC}$
LVPECL Output Current ( $I_{OUT}$ )		
Continuous	.....	50mA
Surge	.....	100mA
Input Current		
Source or sink current on IN, /IN	.....	±50mA
Lead Temperature (soldering, 20 sec.)	.....	+260°C
Storage Temperature ( $T_S$ )	.....	-65°C to +150°C

### Operating Ratings<sup>(Note 2)</sup>

Supply Voltage ( $V_{CC}$ )	.....	3.0V to 3.6V
Ambient Temperature ( $T_A$ )	.....	-40°C to +85°C
Package Thermal Resistance, <b>Note 3</b>		
MLF™ ( $\theta_{JA}$ )		
Still-Air	.....	93°C/W
500lfpm	.....	87°C/W
MLF™ ( $\Psi_{JB}$ )		
Junction-to-Board	.....	60°C/W

**Note 1.** Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to ABSOLUTE MAXIMUM RATING conditions for extended periods may affect device reliability.

**Note 2.** The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

**Note 3.** Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.

## DC ELECTRICAL CHARACTERISTICS<sup>(Note 4)</sup>

Symbol	Parameter	Condition	Min	Typ	Max	Units
$V_{CC}$	Power Supply Voltage		3.0	3.3	3.6	V
$I_{CC}$	Power Supply Current	Max $V_{CC}$ , No Load		22	40	mA

## LVPECL DC ELECTRICAL CHARACTERISTICS<sup>(Note 4)</sup>

$V_{CC} = +3.3V \pm 10\%$  and  $V_{EE} = 0V$ ;  $R_L = 50\Omega$  to  $V_{CC} - 2V$ ;  $T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise noted.

Symbol	Parameter	Condition	Min	Typ	Max	Units
$V_{OH}$	Output HIGH Voltage		$V_{CC} - 1.145$	$V_{CC} - 1.020$	$V_{CC} - 0.895$	V
$V_{OL}$	Output LOW Voltage		$V_{CC} - 1.945$	$V_{CC} - 1.820$	$V_{CC} - 1.695$	V
$V_{IH}$	Input HIGH Voltage		$V_{CC} - 1.225$		$V_{CC} - 0.880$	V
$V_{IL}$	Input LOW Voltage		$V_{CC} - 1.945$		$V_{CC} - 1.625$	V
$V_{CMR}$	LVPECL Common Mode Range		1.2		$V_{CC}$	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 3.46V$			150	μA
$I_{IL}$	Input LOW Current	IN		0.5		μA
		/IN		-300		μA

**Note 4.** The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

**LVTTTL DC ELECTRICAL CHARACTERISTICS**(Note 5)

$V_{CC} = +3.3V \pm 10\%$ ;  $C_L = 20pF$ ,  $T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise noted.

Symbol	Parameter	Condition	Min	Typ	Max	Units
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -3mA$	2.0	—	—	V
$V_{OL}$	Output LOW Voltage	$I_{OH} = -24mA$	—	—	0.5	V
$V_{IH}$	Input HIGH Voltage		2.0	—	—	V
$V_{IL}$	Input LOW Voltage		—	—	0.8	V
$V_{IK}$	Input Clamp Voltage	$I_{IK} = -18mA$	—	—	-1.2	V
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.7V$	—	—	20	$\mu A$
		$V_{IN} = V_{CC}$	—	—	100	$\mu A$
$I_{IL}$	Input LOW Current	$V_{IN} = 0.5V$	—	—	-0.2	$\mu A$
$I_{OUT(SC)}$	LVTTTL Output Short-Circuit Current	$V_{OUT} = 0V$	-275	—	-80	mA

**AC ELECTRICAL CHARACTERISTICS**

$V_{CC} = +3.3V \pm 10\%$ .  $T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise noted.

Symbol	Parameter	Condition	Min	Typ	Max	Units
$f_{MAX}$	Maximum Frequency	LVPECL <b>Note 6</b>	700	—	—	MHz
		LVTTTL <b>Note 7</b>	275	350	—	MHz
$t_{pd}$	Propagation Delay	IN_LVPECL-to-Q_LVTTTL <b>Note 7</b>	1.5	—	2.5	ns
		IN_LVTTTL-to-Q_LVPECL <b>Note 6</b>	100	400	600	ps
$V_{PP}$	LVPECL Input Voltage Swing (Single-Ended)	<b>Note 8</b>	100	—	—	mV
$t_{DC}$	Duty Cycle		45	50	55	%
$t_{jitter}$	Cycle-toCycle Jitter	<b>Note 9</b>			<1	$ps_{RMS}$
	Total Jitter	<b>Note 10</b>			20	$ps_{PP}$
$t_r, t_f$	LVPECL Output Rise/Fall Times (20% to 80%)	At full output swing, <b>Note 5</b>	200	—	500	ns
	LVTTTL Output Rise/Fall Times (10% to 90%)	At full output swing, <b>Note 6</b>	0.5	—	1.0	ns

**Note 5.** The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

**Note 6.**  $R_L = 50\Omega$  to  $V_{CC} - 2V$

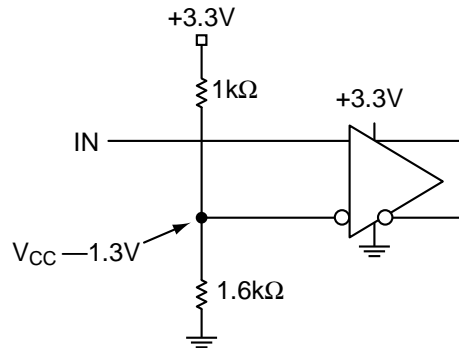
**Note 7.**  $C_L = 20pF$

**Note 8.**  $V_{PP}$  (min) is the minimum input swing for which AC parameters are guaranteed.

**Note 9.** Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles,  $T_n - T_{n-1}$ , where T is the time between rising edges of the output signal.

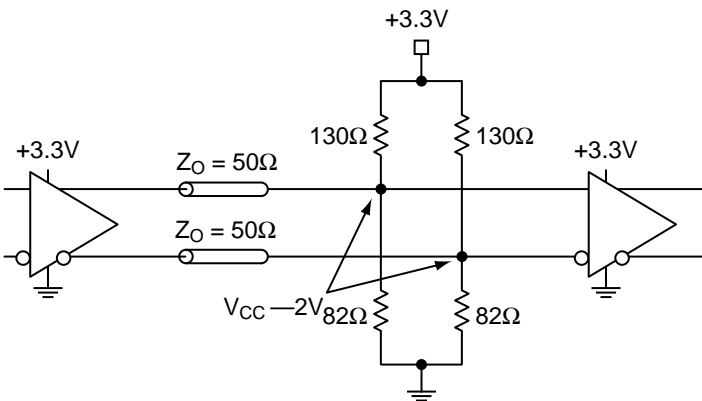
**Note 10.** Total jitter definition: with an ideal clock input of frequency  $\leq f_{MAX}$ , no more than one output edge in  $10^{12}$  output edge will deviate by more than the specified peak-to-peak jitter value.

**LVPECL INPUT INTERFACE APPLICATIONS**

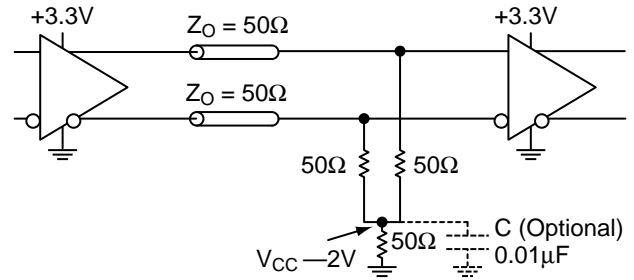


**Figure 1. Single-Ended Input (Terminating unused input)**

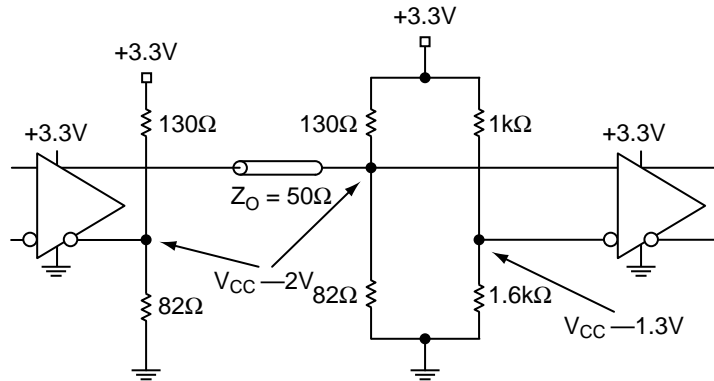
**LVPECL OUTPUT INTERFACE APPLICATIONS**



**Figure 2a. Parallel Thevenin-Equivalent Termination**

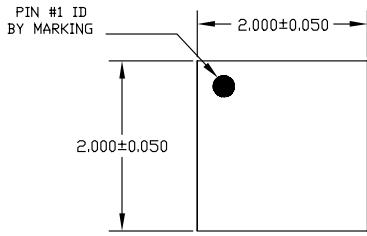


**Figure 2b. Three Resistor "Y Termination"**

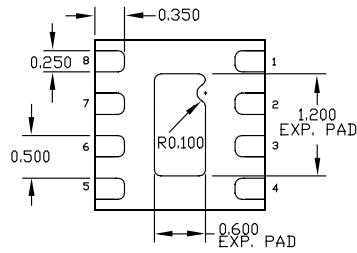


**Figure 2c. Terminating Unused I/O**

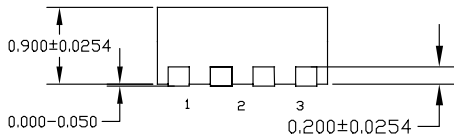
**8 LEAD ULTRA-SMALL EPAD-MicroLeadFrame™ (MLF-8)**



TOP VIEW

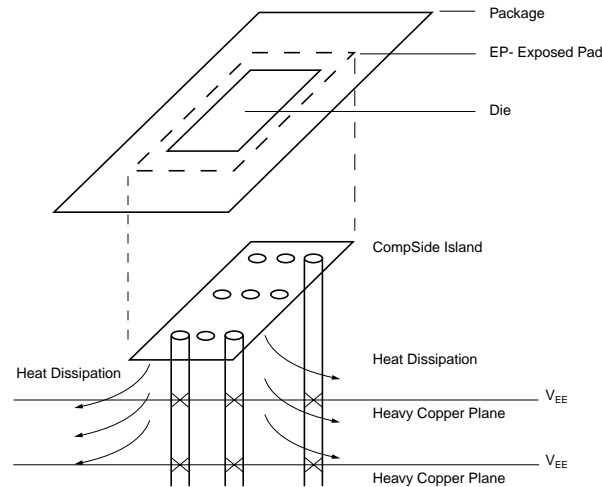


BOTTOM VIEW



SIDE VIEW

- NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
  2. MAX. PACKAGE WARPAGE IS 0.05 mm.
  3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
  4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.



PCB Thermal Consideration for 8-Pin MLF™ Package

**Package Notes:**

- Note 1.** Package meets Level 2 qualification.
- Note 2.** All parts are dry-packaged before shipment.
- Note 3.** Exposed pads must be soldered to a ground for proper thermal management.

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